



# Power MOSFETS

## DATASHEET

**LM40036NAK8A**

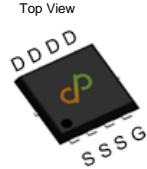
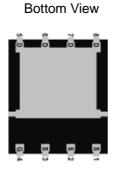
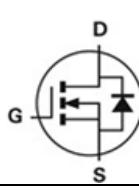
N-Channel  
Enhancement Mode MOSFET

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Quality Management Systems  
ISO 9001:2015 Certificate

## N-Channel Enhancement Mode MOSFET

Pin Description		Product Summary			
PDFN5*6	Symbol	Symbol	N-Channel	Unit	
Top View 			$V_{DSS}$	40	V
			$R_{DS(ON)-Max}$	3.6	$m\Omega$
			ID	92	A

### Feature

- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and  $R_g$  Tested

### Applications

- Power Management in Desktop Computer
- DC/DC Converters

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40036NAK8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	40036 □□□□□□

### Absolute Maximum Ratings ( $T_J=25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage	40	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	
$T_J$	Maximum Junction Temperature	150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$I_{DM}^{\textcircled{1}}$	Pulse Drain Current Tested	$T_c=25^\circ C$	A
$I_D$	Continuous Drain Current	$T_c=25^\circ C$	92
		$T_c=100^\circ C$	58
$P_D$	Maximum Power Dissipation	$T_c=25^\circ C$	50
		$T_c=100^\circ C$	20
$I_{AS}^{\textcircled{2}}$	Avalanche Current, Single pulse	L=0.1mH	A
$E_{AS}^{\textcircled{2}}$	Avalanche Energy, Single pulse	L=0.1mH	mJ

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	$^\circ C/W$
$R_{\theta JA}^{\textcircled{3}}$	Thermal Resistance-Junction to Ambient	Steady State	$^\circ C/W$

Note ① : Max. current is limited by junction temperature.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150  $^\circ C$

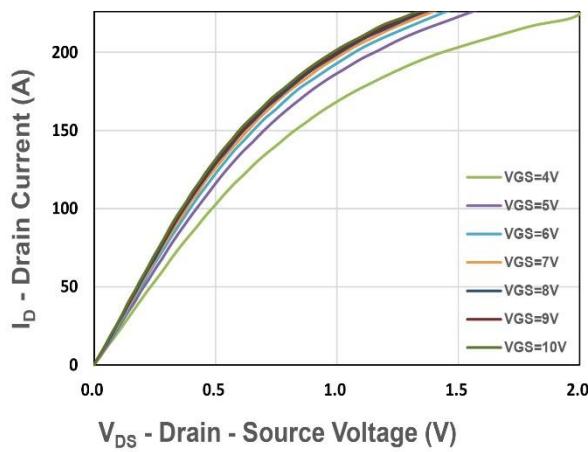
Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

N-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
$\mathbf{BV_{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_{DS}=250\mu\text{A}$	40	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=32\text{V}, V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu\text{A}$	1	1.7	2.2	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$	-	-	$\pm 100$	$\text{nA}$
$R_{DS(\text{ON})}^{\text{(4)}}$	Drain-Source On-state Resistance	$V_{GS}=10\text{V}, I_{DS}=20\text{A}$	-	3	3.6	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_{DS}=15\text{A}$	-	3.9	5	
$g_{fs}$	Forward Transconductance	$V_{DS}=5\text{V}, I_{DS}=10\text{A}$	-	43	-	S
<b>Dynamic Characteristics <sup>(5)</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V},$ $\text{Freq.}=1\text{MHz}$	-	1.6	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V},$ $V_{DS}=20\text{V},$ $\text{Freq.}=1\text{MHz}$	-	3558	-	$\text{pF}$
$C_{oss}$	Output Capacitance		-	279	-	
$C_{rss}$	Reverse Transfer Capacitance		-	230	-	
$t_{d(\text{ON})}$	Turn-on Delay Time	$V_{GS}=10\text{V}, V_{DS}=30\text{V},$ $I_D=1\text{A}, R_{\text{GEN}}=6\Omega$	-	13.7	-	$\text{nS}$
$t_r$	Turn-on Rise Time		-	21.2	-	
$t_{d(\text{OFF})}$	Turn-off Delay Time		-	143.1	-	
$t_f$	Turn-off Fall Time		-	56.2	-	
$Q_g$	Total Gate Charge	$V_{GS}=4.5\text{V}, V_{DS}=20\text{V}$ $I_D=20\text{A}$	-	41.14	-	$\text{nC}$
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=20\text{V},$ $I_D=20\text{A}$	-	89.02	-	
$Q_{gs}$	Gate-Source Charge		-	18.2	-	
$Q_{gd}$	Gate-Drain Charge		-	15.22	-	
<b>Source-Drain Characteristics</b>						
$V_{SD}^{\text{(4)}}$	Diode Forward Voltage	$I_{SD}=10\text{A}, V_{GS}=0\text{V}$	-	0.75	1.1	V
$t_{rr}$	Reverse Recovery Time	$I_F=10\text{A}, V_R=20\text{V}$ $dI_F/dt=100\text{A}/\mu\text{s}$	-	26.5	-	$\text{nS}$
$Q_{rr}$	Reverse Recovery Charge		-	25	-	$\text{nC}$

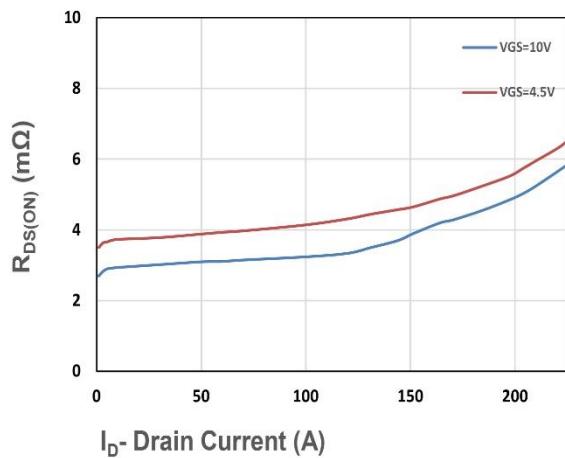
Note <sup>(4)</sup> : Pulse test (pulse width $\leq 300\text{us}$ , duty cycle $\leq 2\%$ ).Note <sup>(5)</sup> : Guaranteed by design, not subject to production testing.

## N-Channel Typical Characteristics



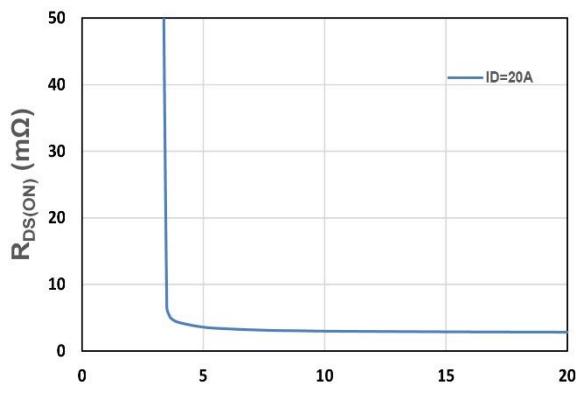
$V_{DS}$  - Drain - Source Voltage (V)

Figure 1. Output Characteristics



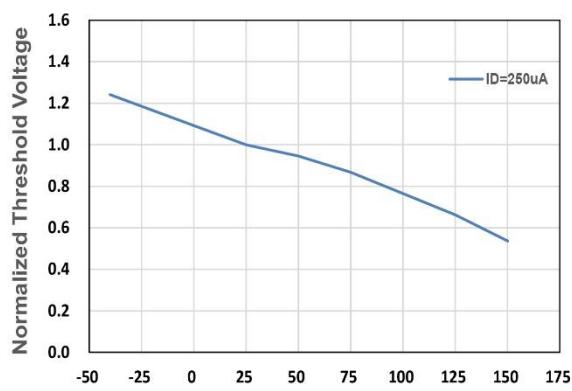
$I_D$ - Drain Current (A)

Figure 2. On-Resistance vs. ID



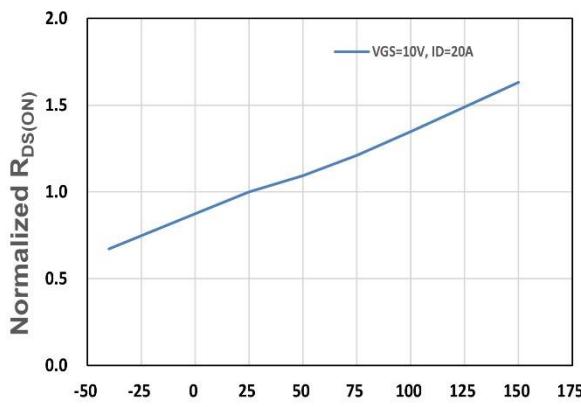
$V_{GS}$  - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



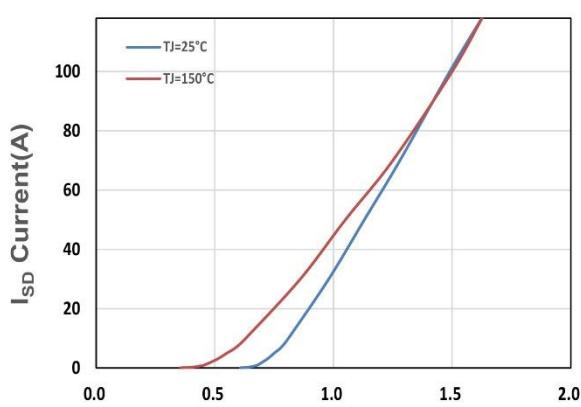
$T_j$ , Junction Temperature(°C)

Figure 4. Gate Threshold Voltage



$T_j$  , Junction Temperature(°C)

Figure 5. Drain-Source On Resistance



$V_{SD}$ , Source-Drain Voltage(V)

Figure 6. Source-Drain Diode Forward

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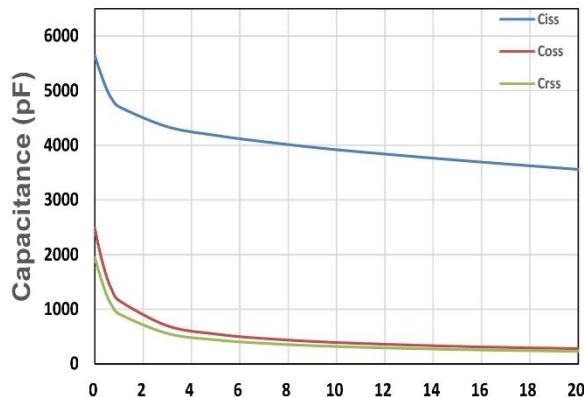


Figure 7. Capacitance

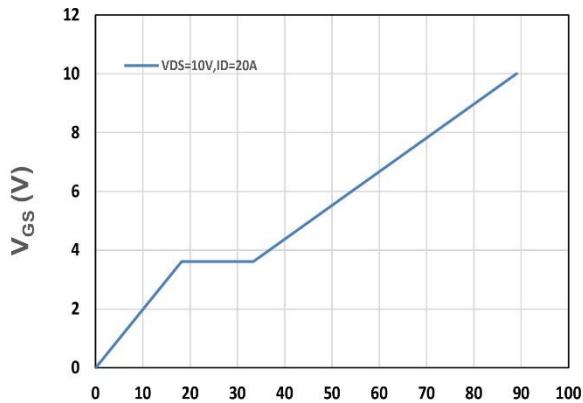


Figure 8. Gate Charge Characteristics

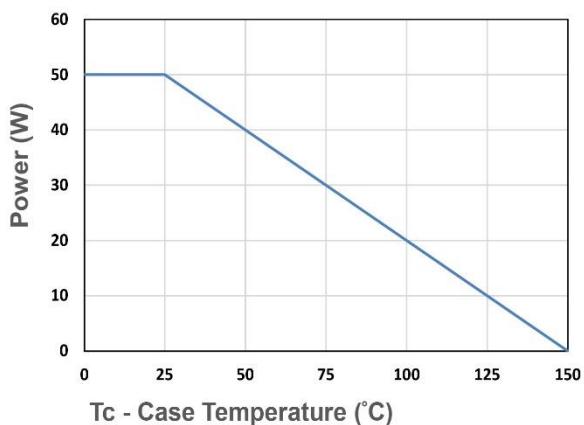


Figure 9. Power Dissipation

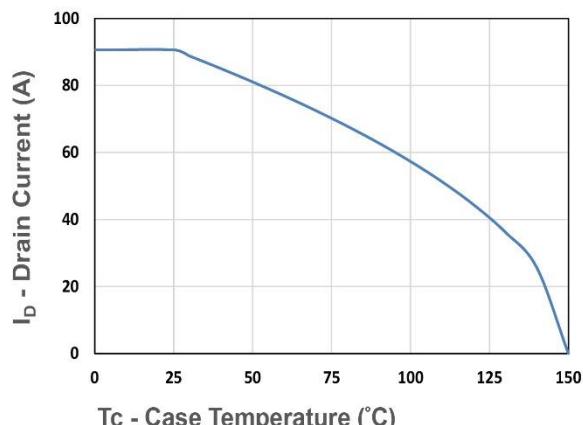


Figure 10. Drain Current

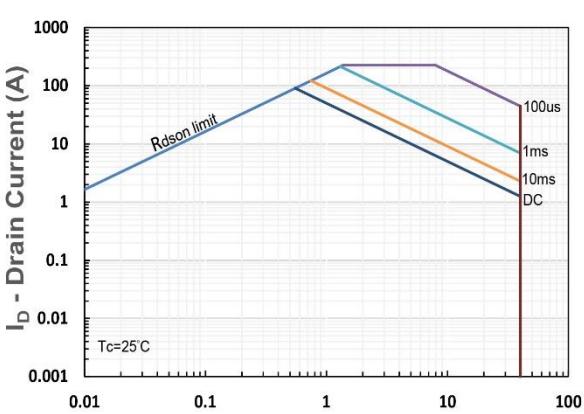


Figure 11. Safe Operating Area

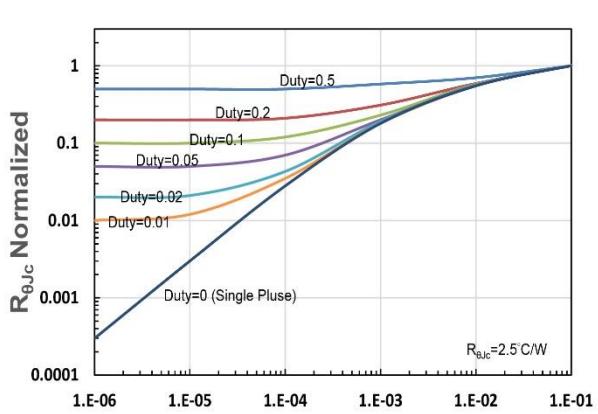


Figure 12.  $R_{\theta JC}$  Transient Thermal Impedance